Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	896	illuminat$3 same chamber same radiation	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/20 10:45
S2	4015	camera same coupled same (processor or CPU)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/17 18:12
S3	6	((illuminat$3 same chamber same radiation) and camera) and (camera same coupled same (processor or CPU))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 11:08
S4	143	(illuminat$3 same chamber same radiation) and camera	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 14:00
S5	109075	process with chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:41
S6	5051	radition wth illumimnat$3 with chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 11:11
S7	5053	radition wth illumimnat$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:42
S8	470255	camera$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:43
S9	3580	camera$1 same coupl$2 same processor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:45
S10	103133	network with internet	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:48

S11	253598	server	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:48
S12	1	((process with chamber) and (radition wth illumimnat$3 with chamber)) and camera$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:48
S13	78	(process with chamber) and (radition wth illumimnat$3 with chamber)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:52
S14	7	((process with chamber) and (radition wth illumimnat$3 with chamber)) and semiconduc$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 10:53
S15	100412	semiconductor and chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 11:09
S16	33	captur$3 same (video or imag$2) same (event or substrate or wafer) near4 chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 14:07
S17	8	camera same captur$3 same (video or imag$2) same (event or substrate or wafer) near4 chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 14:15
S18	33	camera same captur$3 same (video or imag$2) same (event or substrate or wafer) same chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 14:15
S20	15	camera with processor with internet with server	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 18:17
S21	456	725/105	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 15:34

S22	3	725/105 and chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 15:34
S23	29	light with pipe with coupl$3 with camera	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 18:18
S24	1	(light with pipe with coupl$3 with camera) and (view near4 port)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 18:18
S25	5	(light with pipe with coupl$3 with camera) and chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 18:49
S29	56	camera same coupled same light near4 pipe	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 18:50
S30	13	(camera same coupled same light near4 pipe) and chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 18:51
S31	14	chamber with wafer with robot with arm with casset$2 with support	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 14:28
S33	73	determin$3 with position with chamber near8 component	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 19:38
S34	4	(determin$3 with position with chamber near8 component) and camera	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/18 19:38
S36	1230	determin$3 same position same component same chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 10:21

S37	62	(determin$3 same position same component same chamber) and camera	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 10:28
S38	16	((determin$3 same position same component same chamber) and camera) and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/20 10:50
S39	5	(((determin$3 same position same component same chamber) and camera) and wafer) and arm	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 10:28
S40	1	(chamber with wafer with robot with arm with casset$2 with support) with position	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 10:54
S41	1389	camera same determin$3 same (substrate or component or wafer) same mov$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 10:57
S42	288	(camera same determin$3 same (substrate or component or wafer) same mov$5) and (position same analy$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 10:57
S43	46	((camera same determin$3 same (substrate or component or wafer) same mov$5) and (position same analy$4)) and chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 11:55
S44	114	camera same capture same illuminat$3 same outside	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 11:58
S45	12	(camera same capture same illuminat$3 same outside) and chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 12:10
S60	205	(fibrer$1optic or fiberoptic) with camera	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 13:25

S61	52	((fibrer$1optic or fiberoptic) with camera) and chamber	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 13:42
S62	9	(((fibrer$1optic or fiberoptic) with camera) and chamber) and semicond$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 13:42
S64	205	camera with fiberoptic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:15
S66	1563	chamber with imag$3 with process$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:16
S67	254	(chamber with imag$3 with process$4) and arm	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:16
S68	50	((chamber with imag$3 with process$4) and arm) and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:28
S69	10721	determin$4 with position with component$1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:29
S70	3	(((chamber with imag$3 with process$4) and arm) and wafer) and (determin$4 with position with component$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:29
S71	179	(determin$4 with position with component$1) and robot with arm	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:33
S72	21	((determin$4 with position with component$1) and robot with arm) and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:38

S73	459610	image with process$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 15:39
S74	6	(((determin$4 with position with component$1) and robot with arm) and wafer) and (image with process$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 16:06
S75	94	((fibrer$1optic or fiberoptic) with camera) and (chamber or inspection)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/03/19 18:04
S81	29237	trigger$3 with sensor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/19 18:15
S83	978	illuminat$3 same chamber same radiation	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/19 18:16
S86	7	((illuminat$3 same chamber same radiation) and camera) and (camera same coupled same (processor or CPU))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/20 10:46
S88	163	(illuminat$3 same chamber same radiation) and camera	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/20 10:48
S90	21	((determin$3 same position same component same chamber) and camera) and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/20 10:51
S91	1	S90 and trig$6 with sensor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/20 10:51
S92	978	illuminat$3 same chamber same radiation	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/20 10:51

S93	7	S92 and trig$6 with sensor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/20 10:51
S96	20	annot$3 same verb$4 same text$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/23 17:31